# ESDR0524P

# **ESD Protection Diode**

# Low Capacitance ESD Protection for High Speed Data

The ESDR0524P surge protection is designed to protect high speed data lines from ESD. Ultra-low capacitance and low ESD clamping voltage make this device an ideal solution for protecting voltage sensitive high speed data lines. The flow-through style package allows for easy PCB layout and matched trace lengths necessary to maintain consistent impedance between high speed differential lines such as HDMI.

#### Features

- Low Capacitance (0.3 pF Typical, I/O to I/O)
- ESD Rating of Class 3B (Exceeding 8 kV) per Human Body model and Class C (Exceeding 400 V) per Machine Model
- Protection for the Following IEC Standards: IEC 61000-4-2 (±8 kV Contact)
- UL Flammability Rating of 94 V-0
- This is a Pb–Free Device

#### **Typical Applications**

- HDMI
- DVI
- Display Port
- MDDI
- eSATA

### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Operating Junction Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Lead Solder Temperature – Maximum (10 Seconds)	ΤL	260	°C
IEC 61000-4-2 Contact (ESD) IEC 61000-4-2 Air (ESD)	ESD ESD	±12 ±15	kV kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



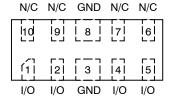
# **ON Semiconductor®**

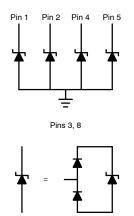
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		MARKING DIAGRAM
	UDFN10 CASE 517BB	4P M▪ ■
4P	= Specific Device	Code
М	= Date Code*	
•	= Pb-Free Packa	age
(Note: Micr	odot may be in eithe	er location)

\*Date Code orientation and/or position may vary depending upon manufacturing location.







#### **ORDERING INFORMATION**

Device	Package	Shipping
ESDR0524PMUTAG	UDFN10 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

See Application Note AND8308/D for further description of survivability specs.

# ESDR0524P

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse Working Voltage	V <sub>RWM</sub>	I/O Pin to GND (Note 1)			5.0	V
Breakdown Voltage	V <sub>BR</sub>	I <sub>T</sub> = 1 mA, I/O Pin to GND	5.5			V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5 V, I/O Pin to GND			1.0	μA
Clamping Voltage	V <sub>C</sub>	I <sub>PP</sub> = 1 A, I/O Pin to GND (8 x 20 μs pulse)			15	V
Junction Capacitance	CJ	V <sub>R</sub> = 0 V, f = 1 MHz between I/O Pins		0.3	0.4	pF
Junction Capacitance	CJ	$V_R$ = 0 V, f = 1 MHz between I/O Pins and GND		0.5	0.8	pF

1. Surge protection devices are normally selected according to the working peak reverse voltage (V<sub>RWM</sub>), which should be equal or greater than the DC or continuous peak operating voltage level.

## ESDR0524P

## **TYPICAL CHARACTERISTICS**

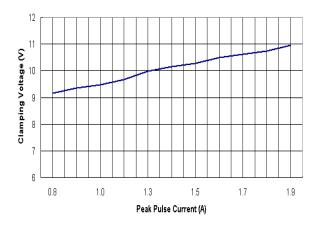


Figure 1. Clamping Voltage vs. Peak Pulse Current

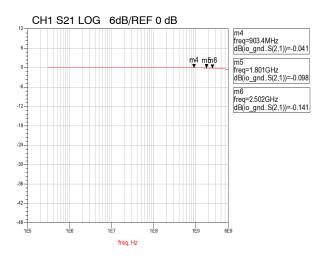


Figure 3. Insertion Loss S21 – I/O to GND

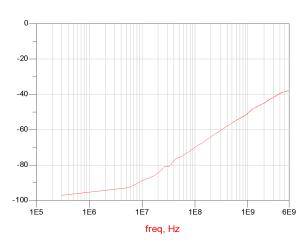


Figure 5. Analog Crosstalk – I/O to I/O

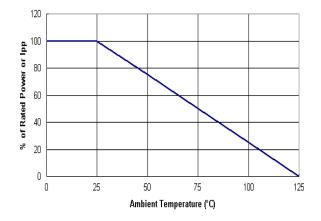


Figure 2. Power Derating Curve

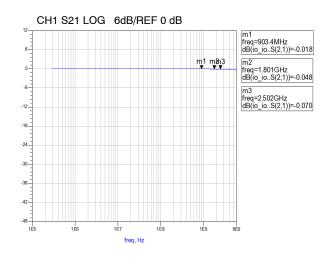
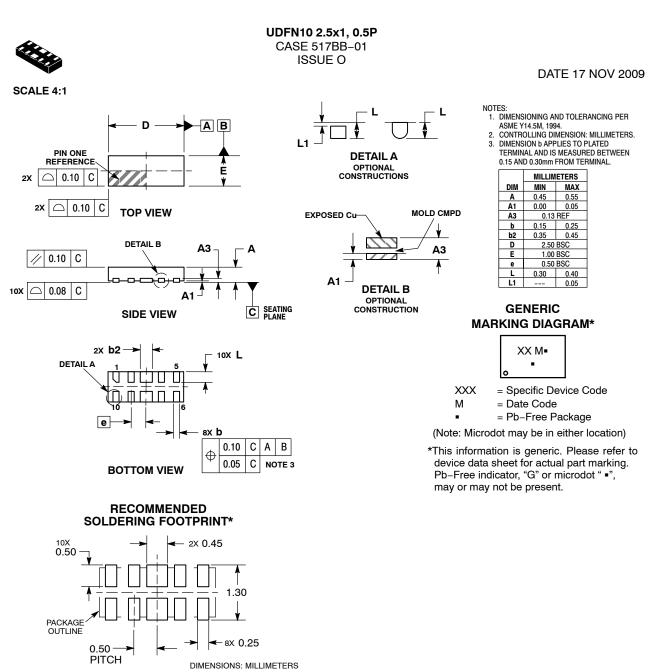


Figure 4. Insertion Loss S21 – I/O to I/O





\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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